AUTOMOTIVE GRADE

COMPLIANT

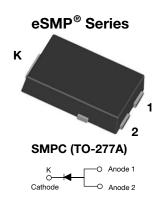
HALOGEN FREE



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Vishay General Semiconductor

Surface-Mount ESD Capability Rectifiers



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	10 A				
V_{RRM}	600 V				
I _{FSM}	120 A				
I _R	10 μA				
V _F at I _F = 10 A, (125 °C)	0.97 V				
T _J max.	175 °C				
Package	SMPC (TO-277A)				
Circuit configuration	Single				

FEATURES

- Very low profile typical height of 1.1 mm
- · Ideal for automated placement
- · Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection in both consumer and automotive applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant and

AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	SE100PJ	UNIT	
Device marking code		10J		
Maximum repetitive peak reverse voltage	V _{RRM}	600	V	
Maximum DC forward current	I _F ⁽¹⁾	10	^	
waximum DC forward current	I _F ⁽²⁾	2.9	A	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	120	А	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175	°C	

Notes

- (1) Mounted on 30 mm x 30 mm aluminum PCB
- (2) Free air, mounted on recommended copper pad area



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 5 A$	$I_F = 5 \text{ A}$ $I_F = 10 \text{ A}$ $T_J = 25 \text{ °C}$	V _F ⁽¹⁾	0.95	-	V
	$I_F = 10 \text{ A}$			1.03	1.1	
	I _F = 5 A	T _J = 125 °C		0.84	-	
	I _F = 10 A			0.97	1.05	
Reverse current	rated V _R	T _J = 25 °C	I _R ⁽²⁾	0.1	10	μА
	rated V _R	T _J = 125 °C		20	150	
Typical reverse recovery time	I _F = 0.5 A, I _R =	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		2.6	-	μs
Typical junction capacitance	4.0 V, 1 MHz		CJ	76	-	pF

Notes

 $^{(1)}$ Pulse test: 300 μs pulse width, 1 $\,\%$ duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	UNIT			
Typical thermal resistance	R _{0JA} (1)	62	°C/W		
Typical trieffial resistance	R _{eJM} ⁽²⁾	1.6	C/VV		

Notes

 $^{(1)}$ Free air, mounted on recommended PCB 1 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

(2) Thermal resistance junction to mount to follow JEDEC® 51-14, transient dual interface test method (TDIM)

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$, unless otherwise noted					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ	V _C	НЗВ	> 8 kV

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE100PJ-M3/H	0.10	Н	1500	7" diameter plastic tape and reel		
SE100PJ-M3/I	0.10	I	6500	13" diameter plastic tape and reel		
SE100PJHM3_A/H (1)	0.10	Н	1500	7" diameter plastic tape and reel		
SE100PJHM3_A/I (1)	0.10	I	6500	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

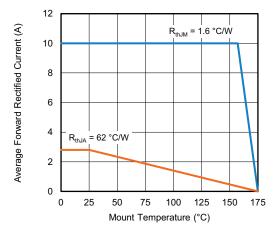


Fig. 1 - Maximum Forward Current Derating Curve

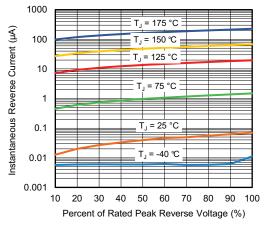


Fig. 4 - Typical Reverse Leakage Characteristics

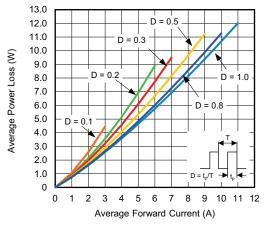


Fig. 2 - Forward Power Loss Characteristics

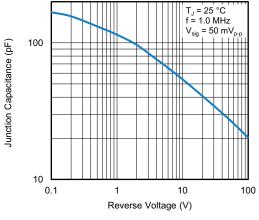


Fig. 5 - Typical Junction Capacitance

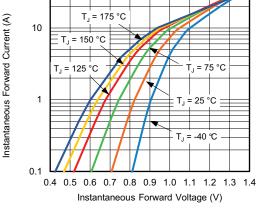


Fig. 3 - Typical Instantaneous Forward Characteristics

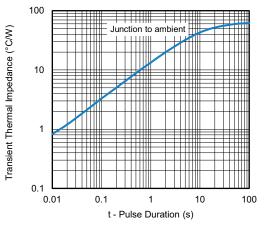
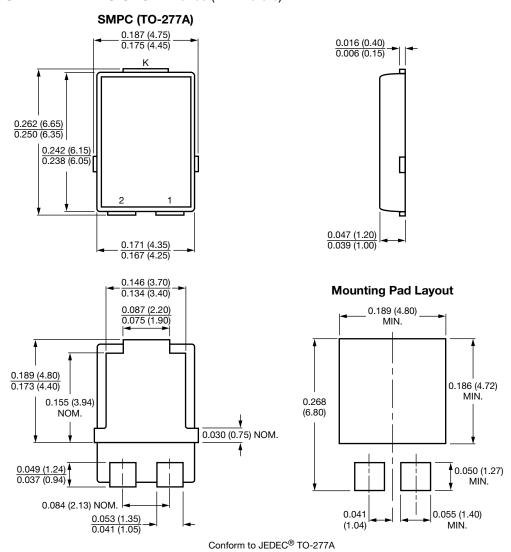


Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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